



MMIC SURFACE MOUNT

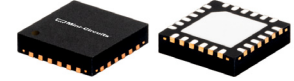
Power Splitter/Combiner

EP2C+

2 Way-0° 50Ω 1800 to 12500 MHz

THE BIG DEAL

- Ultra-Wide bandwidth, 1800 to 12500 MHz
- High power handling, 1.85W as a splitter
- Low cost splitter for 5G Application
- Excellent amplitude unbalance, 0.2 dB typ.
- Good phase unbalance, 6° typ.
- High ESD level
- Small size, 4x4 mm
- Aqueous washable
- DC passing



Generic photo used for illustration purposes only

CASE STYLE: DG1847

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

APPLICATIONS

- WIMAX
- ISM
- Instrumentation
- Radar
- WLAN
- Satellite communications
- LTE

PRODUCT OVERVIEW

Mini-Circuits EP2C+ is a MMIC splitter/combiner designed for wideband operation from 1800 to 12500 MHz. This model provides excellent power ratings in a tiny device package (4x4x1 mm), with up to 1.85W power handling (as a splitter) and up to 0.4A DC current handling. Manufactured using GaAs IPD technology, it provides a high level of ESD protection and excellent reliability.

KEY FEATURES

Feature	Advantages
Wideband, 1800 to 12500 MHz	One power splitter can be used in many applications, saving component count. Also ideal for wideband applications such as military and instrumentation.
Excellent power handling 1.8W as a splitter 0.85W internal dissipation as a combiner	In power combiner applications, half the power is dissipated internally. EP2C+ is designed to handle 0.85W internal dissipation as a combiner allowing reliable operation without excessive temperature rise. Similar splitters implemented as Wilkinson splitters on PCB require big resistors and additional heat sinking. As a splitter, EP2C+ can handle up to 1.85W in a very small package.
DC Passing up to 0.4A	DC current passing is helpful in applications where both RF & DC need to pass through the DUT, such as antenna mounted hardware.
Small size 4 x 4mm QFN package	Tiny footprint saves space in dense layouts while providing low inductance, repeatable transitions, and excellent thermal contact to the PCB.





ELECTRICAL SPECIFICATIONS AT 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Frequency Range		1800		12500	GHz
Insertion Loss above 3.0 dB	1800-3800	—	0.8	1.1	dB
	3800-8500	—	1.1	1.4	
	8500-12500	—	1.8	2.1	
Isolation	1800-3800	7.0	10.0	—	dB
	3800-8500	13.0	16.0	—	
	8500-12500	14.0	17.0	—	
Phase Unbalance	1800-3800	—	3.0	6.0	Degree
	3800-8500	—	6.0	10.0	
	8500-12500	—	11.0	—	
Amplitude Unbalance	1800-3800	—	0.1	0.2	dB
	3800-8500	—	0.2	0.4	
	8500-12500	—	0.7	0.9	
VSWR (Port S)	1800-3800	—	1.5	—	:1
	3800-8500	—	1.3	—	
	8500-12500	—	1.4	—	
VSWR (Port 1-2)	1800-3800	—	1.2	—	:1
	3800-8500	—	1.3	—	
	8500-12500	—	1.6	—	

MAXIMUM RATINGS

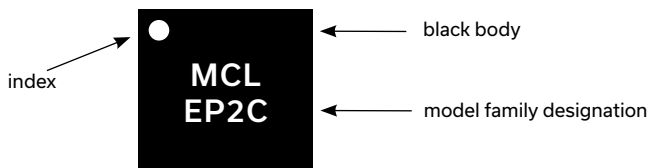
Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-65°C to 150°C
Power Input (as a splitter)	1.85W max.
Internal Dissipation	0.85W max.
DC Current	0.4 A max.

Permanent damage may occur if any of these limits are exceeded.

PAD CONNECTIONS

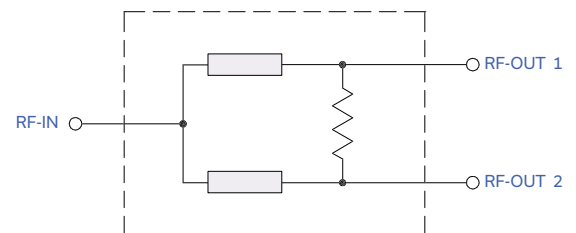
Function	Pad Number
SUM PORT	3
PORT 1	19
PORT 2	12
NOT USED, GROUND EXTERNALLY	1, 2, 4-11, 13-18, 20-24, Paddle

PRODUCT MARKING



Marking may contain other features or characters for internal lot control

SIMPLIFIED ELECTRICAL SCHEMATIC





ADDITIONAL DETAILED TECHNICAL INFORMATION IS AVAILABLE ON OUR DASH BOARD. TO ACCESS [CLICK HERE](#)

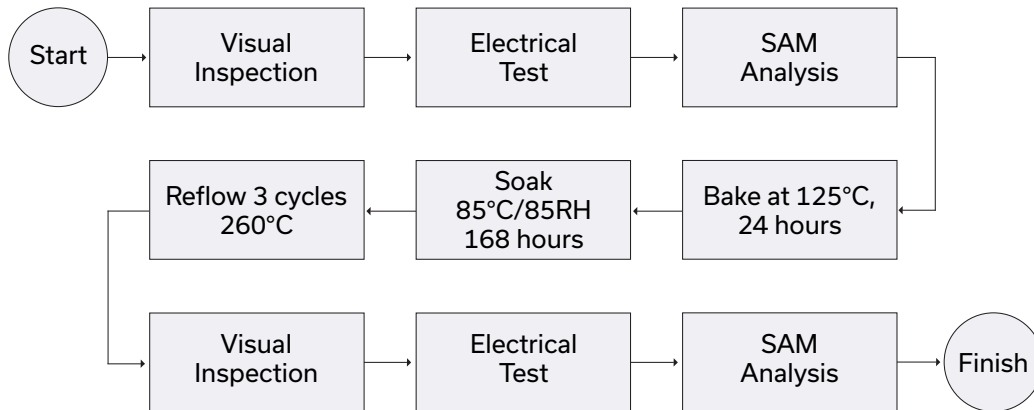
Performance Data	Data Table Swept Graphs S-Parameter (S3P Files) Data Set (.zip file)
Case Style	DG1847 Plastic package, exposed paddle; lead finish: Matte Tin
Tape & Reel Standard quantities available on reel	F68 7" reels with 20, 50, 100, 200, 500, 1000 devices 13" reels with 2000, 3000, 4000 devices
Suggested Layout for PCB Design	PL-442
Evaluation Board	TB-811+
Environmental Ratings	ENV82

ESD RATING

Human Body Model (HBM): Class 2 (1800 to <4000 V) in accordance with ANSI/ESD STM 5.1 - 2001

Machine Model (MM): Class M3 (200 to <400 V) in accordance with ANSI/ESD STM 5.2 - 1999

MSL TEST FLOW CHART



- NOTES**
- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
 - B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
 - C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard. Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp